

Material Data Sheet PTC

Product Class	Limit Temperature Sensor, Leaded Disk B59xxxC* 10.12.2020						
Date							
IMDS ID if available							
Version	5.06						
Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Ceramic	3B	Ba-titanates Pb-titanates Sr-titanates Ca-titanates others*)	69 15 10 5	12047-27-7 12060-00-3 12060-59-2 12049-50-2	34,96	
Termination	Noble Metal Heavy Metal Heavy Metal	1D7 1C14 1C2	Ag Ni Cr	100 100 100	7440-22-4 7440-02-0 7440-47-3	0,018 0,012 0,01	
Solder	Heavy Metal	1C15	Pb +) Sn Ag	92 5 3	7439-92-1 7440-31-5 7440-22-4	26	
Leads	Iron & Steel incl. Allovs Heavy Metal	1A 1C12	Fe Cu	100	7439-89-6 7440-50-8	23	
Encapsulation	Heavy Metal Organic, solid	1C8 4B1	Sn Silicone Lacquer	100	7440-31-5	1,5	
sizes [mm] 4 x 3.5 4 x 42 Not part of a Product	weight range [g] material numbers 0.2 B59011C1040A* 0.25 B59100C*			sizes [mm] 3 x 40	Sum of total weight range [g] 0.21	100 material numbers B59110C*	
Contact	Ronner Christoph			Important remarks	s:		
Division	PPD Q QM			1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are			
Address *\ others: (not declarab	8530 Deutschlandsberg Tel: +43 3462 800 2139 ble or prohibited substan	mailto: functional.ppd-epqm.db@	otdk-electronics.tdk.com	product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated. 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our			
**) typical mass percentage of substance +) listed in the Candidate list of Substances of Very High Concern acc. to Regulation 1907/2006/EC				best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY			
of the European Parliar RoHS - Exemptions for no exemptions; Exemption 6 (a): Li Exemption 6 (b): Li Exemption 6 (c): Ci Exemption 7 (a): Li Exemption 7 (c)-I: Exemption 7 (c)-I: Exemption 5 (c): Ci	or the Product Class / I ead as an alloying element ead as an alloying element opper alloy containing up to ead in high melting tempera lectrical and electronic com	of June 8 th , 2011 on the Product according to A in steel for machining purport in aluminium containing up 0.4 % lead by weight; ature type solder (i.e. lead-byponents containing lead in	atible means that products are of restriction of the use of certain Annex III: (☑ valid ☐ not values and in galvanized steel contain to 0,4 % lead by weight; ased alloys containing 85 % by weight a glass or ceramic other than dielected of 125 V AC or 250 V DC or higher	hazardous substances id) ing up to 0,35 % lead by w ght or more lead); tric ceramic in capacitors, 6	in electrical and electronic e	quipment.	
☐ Exemption 7 (c)-III: Lo ☐ Exemption 15: Lo	ead in dielectric ceramic in	capacitors for a rated voltage viable electrical connection	ge of less than 125 V AC or 250 V D n between semiconductor die and ca	C;	uit Flip Chip packages;		